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Dated: October 29, 2007

Signature: 

(Daryl K. Neff)

Docket No.: TIMI 3.0-003
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Iijima et al.

Application No.: 10/812,349

Confirmation No.: 2684

Filed: March 30, 2004

Art Unit: 2814

For: WIRING CIRCUIT BOARD,
MANUFACTURING METHOD FOR THE
WIRING CIRCUIT BOARD, AND CIRCUIT
MODULE

Examiner: T. X. Le

INFORMATION DISCLOSURE STATEMENT (IDS)

MS RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

It is respectfully requested that the references listed on the enclosed form be made of record and considered with respect to the above-referenced U.S. patent application. A copy of each non-patent reference and each unpublished application is enclosed. Submission of the present Information Disclosure Statement should not be taken as an admission that the cited references are legally available prior art or that the same are pertinent or material.

In the event that any fee is due in connection with the present Information Disclosure Statement, the Commissioner is hereby authorized to charge the same to our Deposit Account No. 12-1095.

Dated: October 29, 2007

Respectfully submitted,

By 

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